<u>S/N 10/820,291</u> <u>PATENT</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gurtej S. Sandhu et al.

Examiner: Dung Le

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Group Art Unit: 2818

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Title:

METHOD FOR FORMING A METALLIZATION LAYER

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This responds to the Office Action mailed on <u>August 21, 2006</u>. Please amend the above-identified patent application as follows.